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ProLight PBVH-7FWE-F2GR 7W Power LED Technical Datasheet Version: 2.2

ProLight Opto ProEngine Series

Features

- · High flux density of lighting source
- · Good color uniformity
- · RoHS compliant
- More energy efficient than incandescent and most halogen lamps
- · Long lifetime
- · AEC-Q102 compliant
- SAE/ECE Compliant

Main Applications

- Bicycle Lamps
- · Exterior Automotive Lighting
- · Floodlight
- Bending Light
- \cdot Daytime Running Light

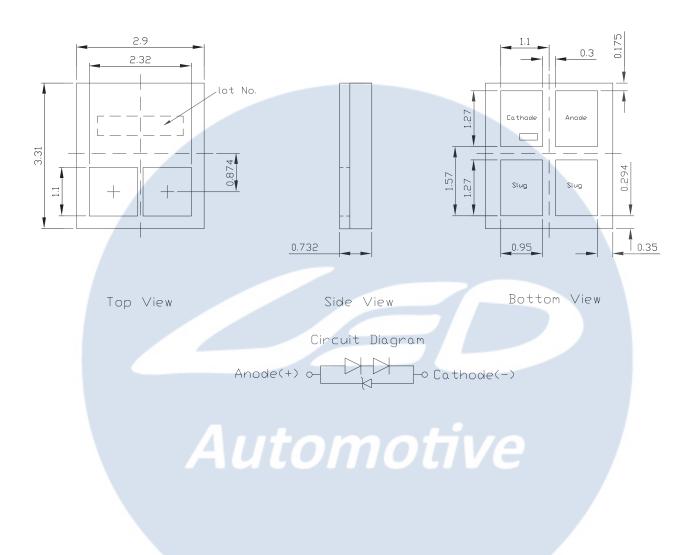
Automotive

Introduction

• The input power is 7 Watt, the multi-chip ultra high power ProEngine Serie delivers never before seen luminous flux output from a single emitter. The superficial illuminating nature of ProEngine makes them the preference bicycle lamps, typical applications include exterior automotive lighting Bending and Daytime Running Light.



Emitter Mechanical Dimensions



Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are \pm 0.1mm.
- 4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
- 5. Please do not use a force of over 1kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

*The appearance and specifications of the product may be modified for improvement without notice.



Flux Characteristics, $T_J = 25^{\circ}C$

Radiation		Dort Number		Luminous F	·lux Φ _v (lm)	
	Color	Part Number	@1000mA Refer @1200		21200mA	
Pattern		Emitter	Min.	Тур.	Min.	Тур.
Lambertian	White	PBVH-7FWE-F2GR	660	800	760	910

• ProLight maintains a tolerance of ± 7% on flux and power measurements.

• Please do not drive at rated current more than 1 second without proper heat sink.

Electrical Characteristics, T_J = 25°C

		Forward Voltage V _F (V) Refer		Real Thermal Resistance	Electrical Thermal Resistance	
Color	Min.	@1000mA Typ.	Max.	@1200mA Typ.	Junction to Slug (°C/ W)	Junction to Slug (°C/W)
White	5.9	6.5	7.4	6.6	3.4	2.1

• ProLight maintains a tolerance of ± 0.1V for Voltage measurements.

Optical Characteristics at 1000mA, T_J = 25°C

Radiation Pattern	Color	Iton _{Col}	or Temperature Typ.	сст С мах.	Angle (degrees) 2 θ _{1/2}
		5380 K	5620 K	5860 K	120
Lambertian	W/bito	5620 K	5880 K	6140 K	120
Lambertian	White	5870 K	6150 K	6430 K	120
		6140 K	6450 K	6760 K	120

• ProLight maintains a tolerance of ± 5% for CCT measurements.

Viewing



Absolute Maximum Ratings

White
1500
1500 (less than 1/10 duty cycle@1KHz)
150°C
175°C
-40°C - 125°C
-40°C - 125°C
3
Not designed to be driven in reverse bias
up to 8

Note: * The LED chip exhibits excellent performance but slight package discoloration occurs at highest temperatures. Exemplary median lifetime for T_J = 175°C is 100h.

Photometric Luminous Flux Bin Structure

Color	Bin Code	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)	Available Color Bins
	D1	660	700	All
	D2	700	730	All
	D3	730	760	All
	D4	760	790	All
White	D5	790	825	All
	D6	825	860	[1]
	D7	860	900	[1]
	D8	900	940	[1]
	D9	940	980	[1]

• ProLight maintains a tolerance of \pm 7% on flux and power measurements.

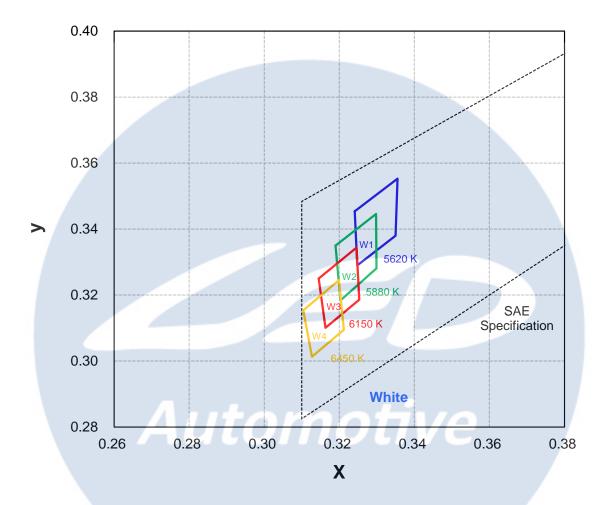
• The flux bin of the product may be modified for improvement without notice.

• ^[1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order Possibility.



Color Bin

White Binning Structure Graphical Representation



White Bin Structure

Bin Code	х	У	Typ. CCT (K)	Bin Code	х	у	Тур. ССТ (К)
	0.3241	0.3454			0.3145	0.3250	
W1	0.3248	0.3290	5620	W3	0.3163	0.3101	6150
VVI	0.3350	0.3380	5020	VV 3	0.3253	0.3186	0150
	0.3355	0.3553			0.3246	0.3344	
	0.3190	0.3350			0.3104	0.3154	
W2	0.3203	0.3184	5880	W4	0.3127	0.3013	6450
VVZ	0.3299	0.3281	5000	VV4	0.3212	0.3095	0430
	0.3298	0.3446			0.3199	0.3245	

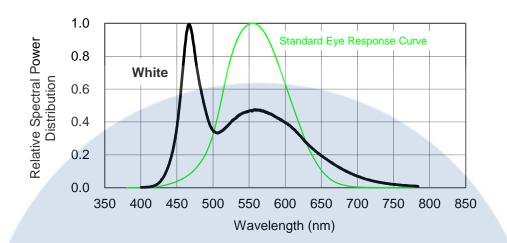
• Tolerance on each color bin (x, y) is ± 0.005

2025/05 | DS-1640



Color Spectrum, T_J = 25°C

1. White

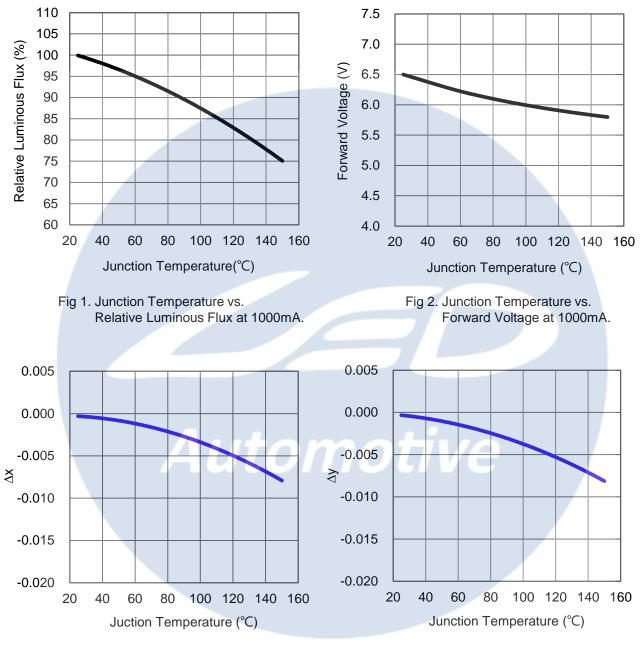


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2025/05 | DS-1640



Junction Temperature Relative Characteristics



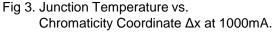
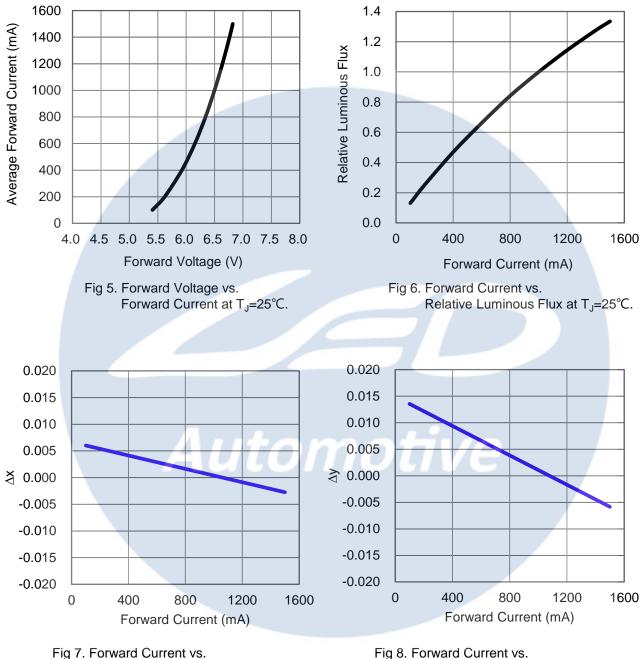


Fig 4. Junction Temperature vs. Chromaticity Coordinate Δy at 1000mA.



Forward Current Relative Characteristics



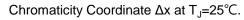
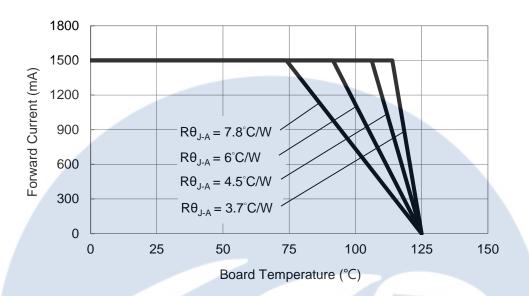


Fig 8. Forward Current vs. Chromaticity Coordinate Δy at T_J=25°C.

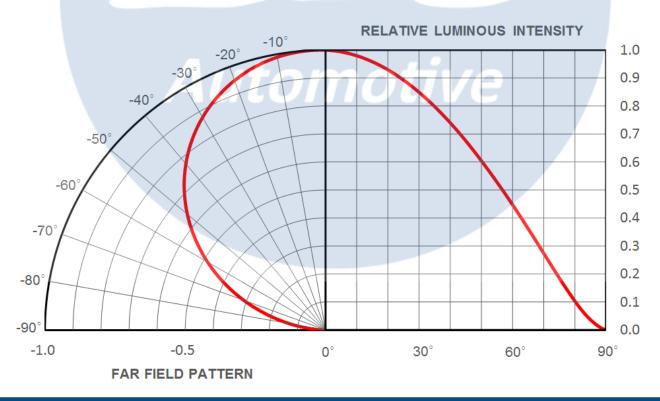


Board Temperature vs. Maximum Forward Current

Maximum Forward Current



Typical Representative Spatial Radiation Pattern





Moisture Sensitivity Level – JEDEC Level 1

			Soak Requirements			
Level	el Floor Life		Standard		Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

				Soak Requirements			
Level	Floor	r Life	Stan	dard	Accelerated Environment		
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions	
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA	
2	1 year	≤30°C / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA	
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH	
3	168 hours	≤30°C / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH	
4	72 hours	≤30°C / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH	
5	48 hours	≤30°C / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH	
5a	24 hours	≤30°C / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH	
6	Time on Label (TOL)	≤30°C / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA	





Reliability testing in accordance with AEC-Q102

The development of this product included extensive operational life-time testing and environmental testing. Table 1 summarizes the tests applied and cumulative test results obtained from testing performed in accordance with AEC-Q102.

Table 1. Operating life, mechanical and environmental tests performed on it's package in accordance with AEC-Q102.

#	STRESS	ABV	Conditions	Duration	Failure Criteria	Rejects
<u>1</u>	Pre- and Post-Stress Electrical Test	TEST	Test is performed as specified in the applicable stress reference at room temperature.	N/A	See notes [2]	0
<u>A1</u>	Pre-conditioning	PC	Soak Tamb = 85 °C, RH = 85% Reflow soldering	N/A	See notes [2]	0
<u>A2a</u>	Wet High Temperature Operating Life	WHTOL 1	Tambient = 85 °C / 85% RH IF = max. DC [1]	1000 hours	See notes [2]	0
<u>A3a</u>	Power Temperature Cycling	PTC	-40°C to 125°C, 10 minutes dwell, 20 minutes transfer (1 hour cycle), 2 minutes ON/2 minutes OFF, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>A4</u>	Temperature Cycling	тс	-40°C to 125°C,15 minutes dwell	1000 cycles	See notes [2]	0
<u>B1a</u>	High Temperature Operating Life	HTOL1	Tsolder =85°C, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>B1b</u>	High Temperature Operating Life	HTOL2	Maximum specified Tsolder, IF = max. DC [1]	1000 hours	See notes [2]	0
<u>C9</u>	Thermal Resistance	TR	All qualification parts submitted for testing	N/A	See notes [2]	0
C10	Solderability	SD	245 °C ± 5 °C	3s	See notes [3]	0
<u>C12</u>	Hydrogen Sulphide	H2S	Corrosion class A: (preferred) Duration 336 h at 40 °C and 90% RH. H2S concentration: 15ppm	336 hours	See notes [2]	0
<u>E3</u>	Electrostatic Discharge Human Body Model	НВМ	ANSI/ESDA/JEDEC JS-001	N/A	See notes [3]	0
<u>G2</u>	Vibration Variable Frequency	VVF	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis	N/A	See notes [3]	0
<u>G3</u>	Mechanical Shock	MS	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis	N/A	See notes [3]	0

Notes:

1. Depending on the maximum derating curve.

2. Criteria for judging failure

ltem	Test Condition	Criteria for Judgement		
nem	Min.		Max.	
Forward Voltage (V _F)	I _F = max DC		Initial Level x 1.1	
Luminous Flux or	I _F = max DC	Initial Level x 0.8		
Radiometric Power (Φ_V)	IF = max b c			
Reverse Current (I _R)	$V_R = 5V$		50 µA	

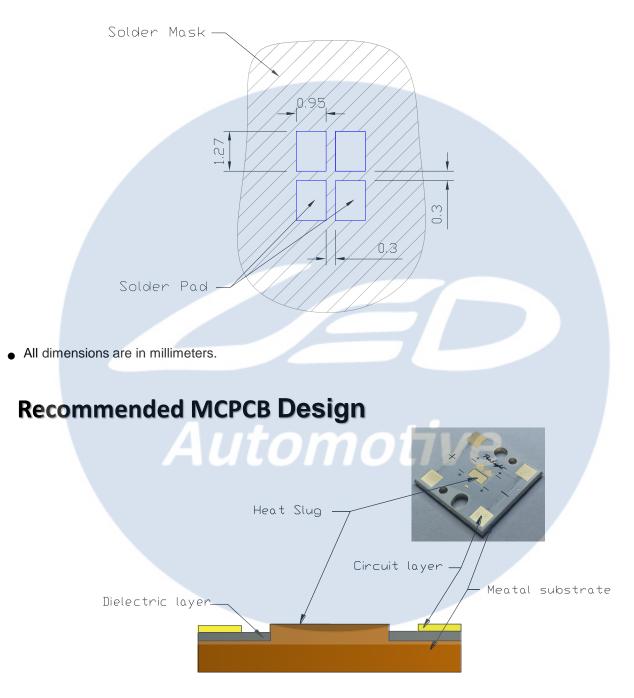
* The test is performed after the LED is cooled down to the room temperature.

3. A failure is an LED that is open or shorted.



Recommended Solder Pad Design

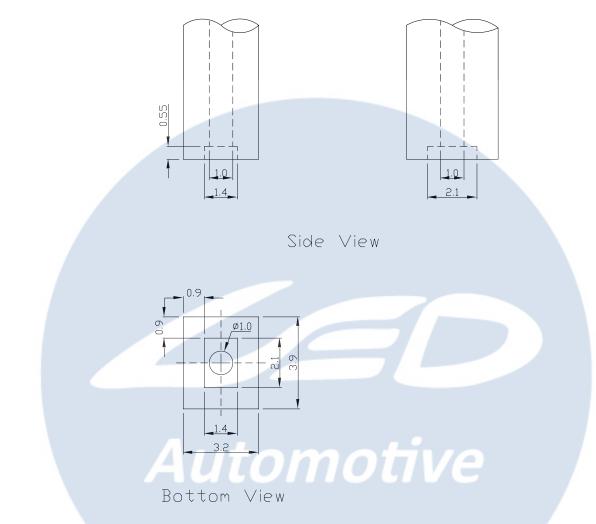
Standard Emitter



- Copper(Cu) substrate is recommended.
- The thermal conductivity of dielectric layer in the Aluminum(AI) substrate is greater or equal than 6w/mk.
- If the thermal conductivity of dielectric layer equal to 2w/mk, the power consumption should be lower than 20w.

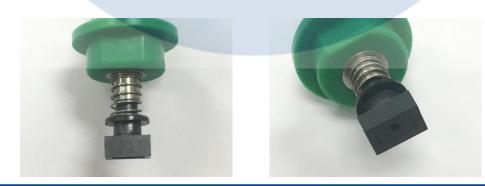


Recommended Suction Nozzle Design



Notes:

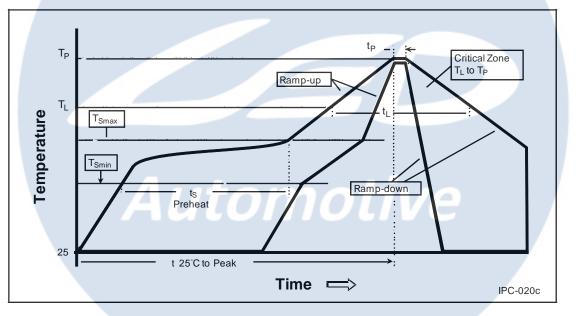
- 1. All dimensions are in millimeters and tolerances are $\pm\,0.05\text{mm}.$
- 2. Recommended the material of suction nozzle was PEEK.
- 3. The actual suction nozzle like below picture.





Reflow Soldering Condition

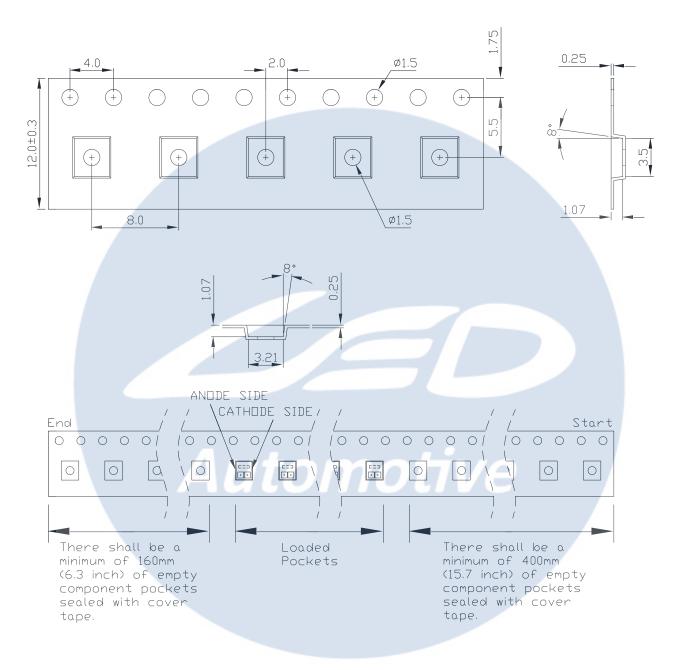
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp-Up Rate	3°C / second max.	3°C / second max.
(T _{Smax} to T _P)		3 C7 second max.
Preheat		
– Temperature Min (T _{smin})	100°C	150°C
– Temperature Max (T _{Smax})	150°C	200°C
– Time (t _{smin} to t _{smax})	60-120 seconds	60-180 seconds
Time maintained above:		
– Temperature (T _L)	183°C	217°C
– Time (t ₁)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (T _P)	240°C	260°C
Time Within 5°C of Actual Peak	10-30 seconds	20-40 seconds
Temperature (t _P)		20-40 seconds
Ramp-Down Rate	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



Emitter Reel Packaging

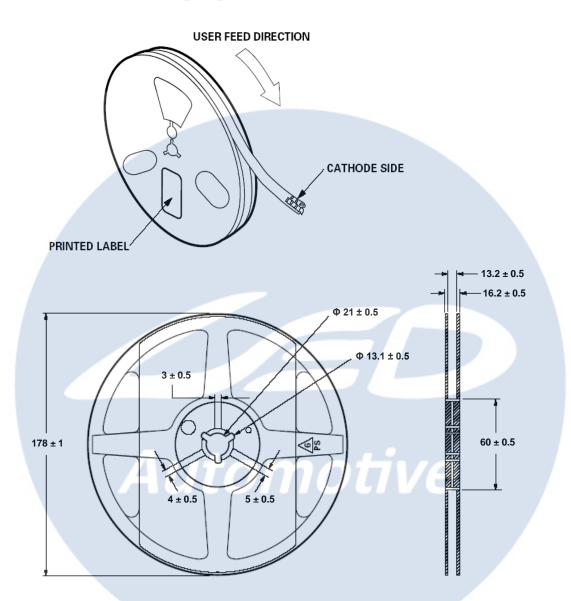


Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are \pm 0.1mm.



Emitter Reel Packaging



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 500 or 1000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.



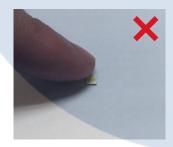
Precaution for Use

- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

Handling of Lens LEDs

Notes for handling of lens LEDs

- Please do not use a force of over 1kgf impact or pressure on the lens, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the lens especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the lens.
- Please store the LEDs away from dusty areas or seal the product against dust.
- Please do not mold over the lens with another resin. (epoxy, urethane, etc)





2025/05 | DS-1640



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